

## SE30PAB, SE30PAD, SE30PAG, SE30PAJ

Vishay General Semiconductor

AUTOMOTIVE

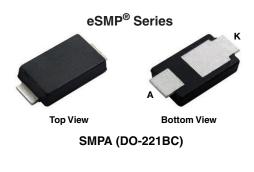
RoHS

COMPLIANT

HALOGEN

FREE

## **Surface-Mount ESD Capability Rectifiers**



Anode Cathode

#### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	3.0 A				
V <sub>RRM</sub>	100 V, 200 V, 400 V, 600 V				
I <sub>FSM</sub>	32 A				
$V_F$ at $I_F = 3.0$ A ( $T_A = 125$ °C)	1.00 V				
I <sub>R</sub>	5 μΑ				
T <sub>J</sub> max.	175 °C				
Package	SMPA (DO-221BC)				
Circuit configuration	Single				

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Not recommended for PCB bottom side wave mounting
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

General purpose, power line polarity protection, in both consumer and automotive applications.

#### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE30PAB	SE30PAD	SE30PAG	SE30PAJ	UNIT
Device marking code		30B	30D	30G	30J	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	200	400	600	V
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	3.0				А
Maximum DC forward current	I <sub>F</sub> <sup>(2)</sup>	1.4				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	32			Α	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175				°C

#### Notes

- (1) Mounted on 20 mm x 20 mm pad areas, 2 oz. FR4 PCB
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST (	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1.5 A	T <sub>A</sub> = 25 °C		0.98	-	V
	I <sub>F</sub> = 3.0 A		V <sub>E</sub> <sup>(1)</sup>	1.07	1.16	
	I <sub>F</sub> = 1.5 A	T <sub>A</sub> = 125 °C	VF (')	0.88	=	
	I <sub>F</sub> = 3.0 A			1.00	1.10	
Reverse current	Datad V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	=	5	μА
	Rated V <sub>R</sub>	T <sub>A</sub> = 125 °C	IR (-)	7	100	
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	1.3	-	μs
Typical junction capacitance	4.0 V, 1 MHz		CJ	13	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °c unless otherwise noted)						
PARAMETER SYMBOL SE30PAB SE30PAD SE30PAG SE30PAJ UNIT						UNIT
Typical thermal registance		120				°C/W
Typical thermal resistance	R <sub>0JM</sub> (2)	9			C/VV	

#### **Notes**

 $^{(1)}$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

Mounted on 20 mm x 20 mm pad areas, 2 oz. FR4 PCB;  $R_{\theta JM}$  - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ( $T_A = 25~^{\circ}\text{C}$ unless otherwise noted)							
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE							
AEC-Q101-001 Human body model (contact mode) $C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$ $V_C$ H3B $> 8 \text{ kV}$							

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE30PAJ-M3/I	0.033	I	14 000	13" diameter plastic tape and reel		
SE30PAJHM3/I (1)	0.033	l	14 000	13" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified

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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

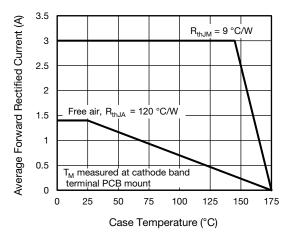


Fig. 1 - Maximum Forward Current Derating Curve

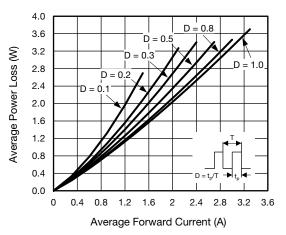


Fig. 2 - Forward Power Loss Characteristics

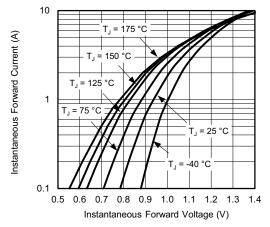


Fig. 3 - Typical Instantaneous Forward Characteristics

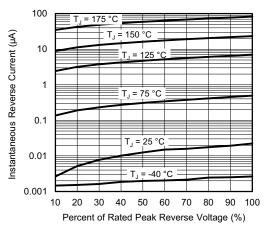


Fig. 4 - Typical Reverse Leakage Characteristics

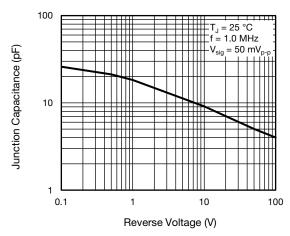


Fig. 5 - Typical Junction Capacitance

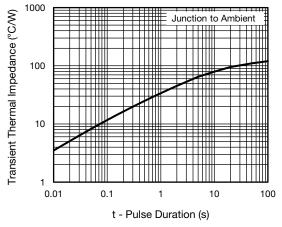


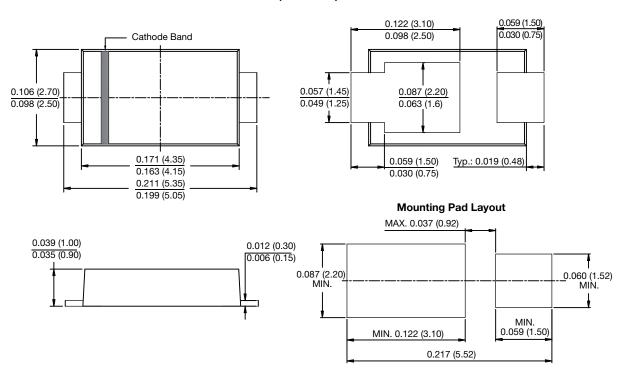
Fig. 6 - Typical Transient Thermal Impedance

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#### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### **SMPA (DO-221BC)**





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